Electronic Acknowledgement Receipt				
EFS ID:	1232688			
Application Number:	10632552			
Confirmation Number:	2572			
Title of Invention:	Semiconductor multi-package module having package stacked over die-up flip chip ball grid array package and having wire bond interconnect between stacked packages			
First Named Inventor:	Marcos Karnezos			
Customer Number:	22470			
Filer:	Bill Kennedy/Paula Hurley			
Filer Authorized By:	Bill Kennedy			
Attorney Docket Number:	CPAC 1017-5			
Receipt Date:	03-OCT-2006			
Filing Date:	02-AUG-2003			
Time Stamp:	14:12:09			
Application Type:	Utility			
International Application Number:				
Payment information:				
Submitted with Payment	yes			
Payment was successfully received in RAM	\$680			

Deposit Acco	ount				
File Listin	ng:				
Document	Document Description	File Name	File Size(Bytes)	Multi	Pages

Part

1248

RAM confirmation Number

Number

1		efsnoaids20061003.pdf	160740	yes	4
		Multipart Description	1		
	Doc Desc  Notice of Appeal Filed		Start	Start End	
			1		
	Information Disclosure Statement (IDS) Filed		2	4	
Warnings:		<u>'</u>			
Information:					
2	Fee Worksheet (PTO-875)	fee-info.pdf	8375	no	2
Warnings:					
Information:					
		Total Files Size (in bytes):	169115		

This Acknowledgement Receipt evidences receipt on the noted date by the USPTO of the indicated documents, characterized by the applicant, and including page counts, where applicable. It serves as evidence of receipt similar to a Post Card, as described in MPEP 503.

## New Applications Under 35 U.S.C. 111

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

## National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.